Preferred Device

# POWERTAP<sup>™</sup> II SWITCHMODE<sup>™</sup> Power Rectifier

The SWITCHMODE Power Rectifier uses the Schottky Barrier principle with a platinum barrier metal. This state–of–the–art device has the following features:

#### Features

- Dual Diode Construction May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 150°C Operating Junction Temperature
- Recyclable Epoxy
- Guaranteed Reverse Avalanche Energy Capability
- Improved Mechanical Ratings
- Pb-Free Packages are Available\*

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25-40 lb-in Max
- Base Plate Torques: See procedure given in the Package Outline Section

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>C</sub> = 125°C) Per Leg Per Device	I <sub>F(AV)</sub>	100 200	A
Peak Repetitive Forward Current, (At Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 100°C)	I <sub>FRM</sub>	200	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	1500	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/µs

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



## **ON Semiconductor®**

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## LOW V<sub>F</sub> SCHOTTKY BARRIER RECTIFIER 200 AMPERES, 30 VOLTS



#### MARKING DIAGRAM



B20030L	= Specific Device Code
MCC	= Mold Compound Code
А	= Assembly Location
YY	= Year
WW	= Work Week
G	= Pb-Free Package

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBRP20030CTL	POWERTAP II	25 Units/Tray
MBRP20030CTLG	POWERTAP II (Pb-Free)	25 Units/Tray

Preferred devices are recommended choices for future use and best overall value.

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#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.45	°C/W
ELECTRICAL CHARACTERISTICS			
Maximum Instantaneous Forward Voltage (Note 1)	V <sub>F</sub>	0.50	V

$(I_F = 200 \text{ Amps}, T_C = +125^{\circ}\text{C})$ $(I_F = 200 \text{ Amps}, T_C = +25^{\circ}\text{C})$	۷F	0.52 0.60	v	
Maximum Instantaneous Reverse Current (Note 1), (Rated dc Voltage, $T_C$ = +25°C)	I <sub>R</sub>	5.0	mA	

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle <[2%.

## MAXIMUM MECHANICAL RATINGS

Terminal Penetration:	0.235 max
Terminal Torque:	25–40 in-lb max
Mounting Torque — Outside Holes:	30–40 in-lb max
Mounting Torque — Center Hole:	8–10 in-lb max
Seating Plane Flatness	1 mil per in. (between mounting holes)

#### POWERTAP MECHANICAL DATA APPLIES OVER OPERATING TEMPERATURE

Vertical Pull 2 in. Lever Pull 250 lbs. max 50 lbs. max

Note: While the POWERTAP is capable of sustaining these vertical and levered tensions, the intimate contact between POWERTAP and heat sink may be lost. This could lead to thermal runaway. The use of very flexible leads is recommended for the anode connections. Use of thermal grease is highly recommended.

http://onsemi.com 2

## **MOUNTING PROCEDURE**

The POWERTAP package requires special mounting considerations because of the long longitudinal axis of the copper heatsink. It is important to follow the proper tightening sequence to avoid warping the heatsink, which can reduce thermal contact between the POWERTAP and heat sink.

2-3 TURNS

2-3 TURNS

5–10 IN-LB

POWER

HEAT

POWER

HEAT

POWER

HEAT

2-3 TURNS

**FINGER-TIGHT** 

FINGER-TIGHT

2-3 TURNS

2-3 TURNS

10 IN-LB

TAP

SINK

TAP

SINK

TAP

SINK

## STEP 1:

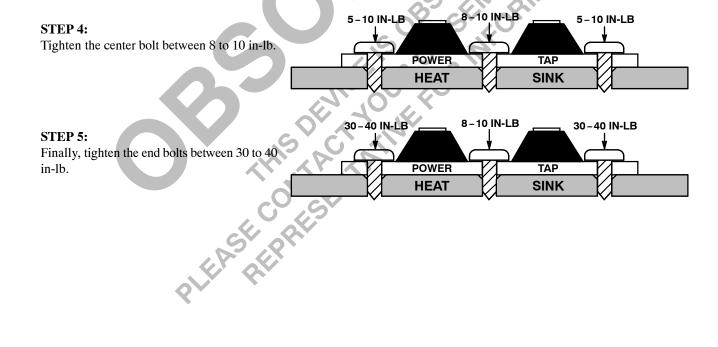
Locate the POWERTAP on the heatsink and start mounting bolts into the threads by hand (2 or 3 turns).

### **STEP 2:**

Finger tighten the center bolt. The bolt may catch on the threads of the heatsink so it is important to make sure the face of the bolt or washer is in contact with the surface of the POWERTAP.

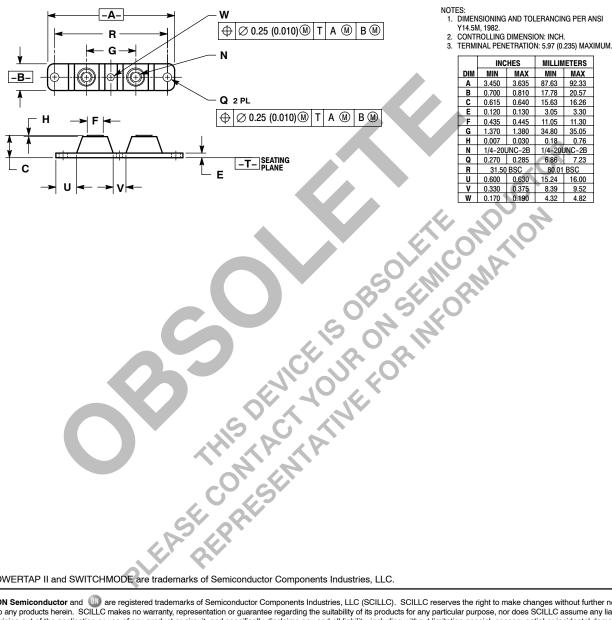
### **STEP 3:**

Tighten each of the end bolts between 5 to 10 in-lb.



#### PACKAGE DIMENSIONS

CASE 357C-03 POWERTAP PLASTIC PACKAGE ISSUE E



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